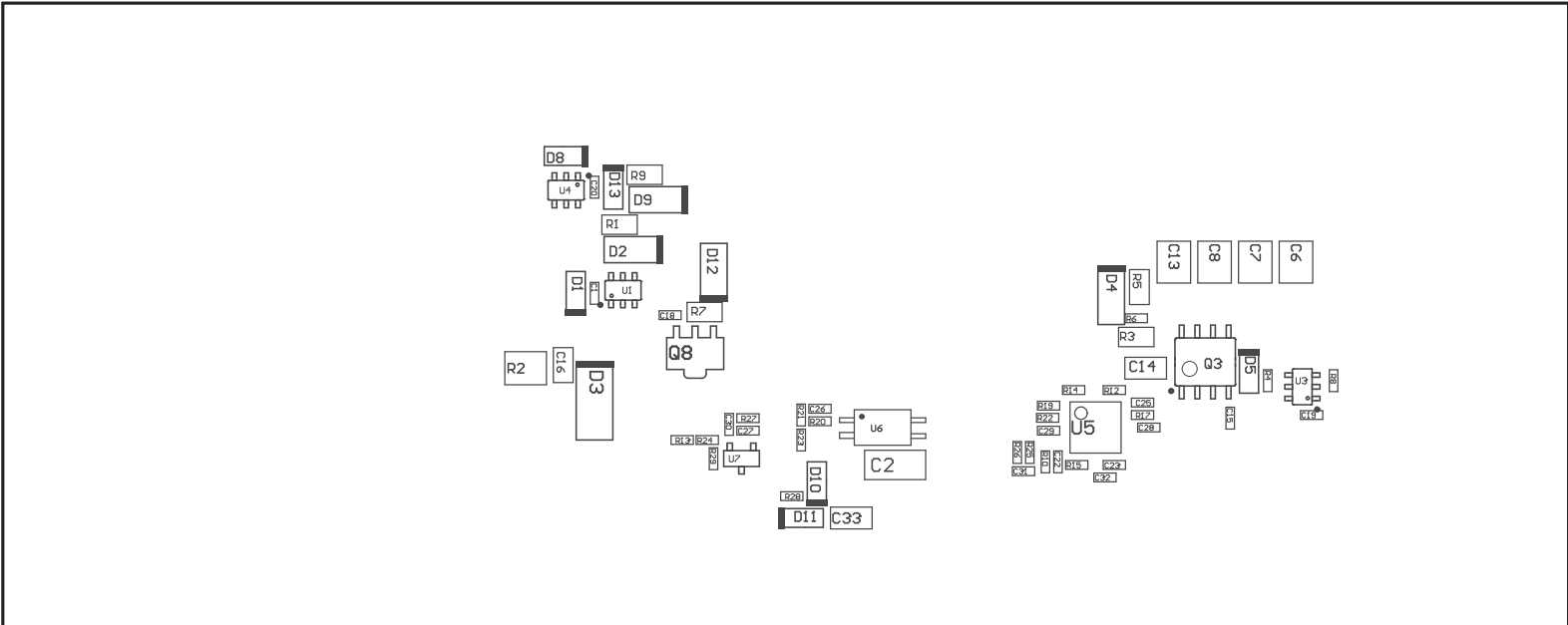


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: PMP3162 | REV: C | SUN REV: Not In VersionControl |
| IGNORE -> Top Overlay | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 5/28/2014 1:13:01 PM | TEXAS INSTRUMENTS | |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|----------------------------------|--------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP3162 | REV: C | SUN REV: Not In VersionControl |
| | IGNORE -> Bottom Overlap | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 5/28/2014 1:13:02 PM | | TEXAS INSTRUMENTS |

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